

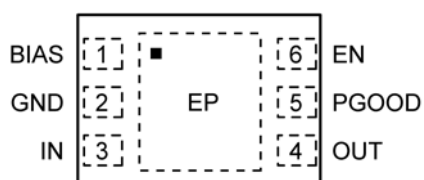
Ordering Information

Part Number	Voltage ⁽¹⁾	Marking Code ⁽²⁾	Temperature Range	Package	Lead Finish ⁽³⁾
MIC47050-1.2YML ⁽⁴⁾	1.2	ZG4	-40°C to +125°C	6-Pin 2mm x 2mm MLF [®]	Pb-Free
MIC47050-1.8YML ⁽⁴⁾	1.8	ZGG	-40°C to +125°C	6-Pin 2mm x 2mm MLF [®]	Pb-Free
MIC47050YML ⁽⁴⁾	ADJ	ZGA	-40°C to +125°C	6-Pin 2mm x 2mm MLF [®]	Pb-Free
MIC47050-1.2YMT ⁽⁵⁾⁽⁶⁾	1.2	ZG4	-40°C to +125°C	6-Pin 2mm x 2mm Thin MLF [®]	Pb-Free
MIC47050-1.8YMT ⁽⁵⁾⁽⁶⁾	1.8	ZGG	-40°C to +125°C	6-Pin 2mm x 2mm Thin MLF [®]	Pb-Free
MIC47050YMT ⁽⁵⁾	ADJ	ZGA	-40°C to +125°C	6-Pin 2mm x 2mm Thin MLF [®]	Pb-Free

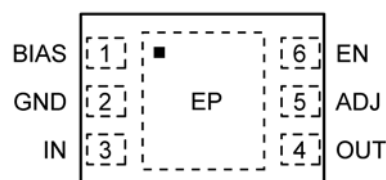
Notes:

1. Other voltage available. Contact Micrel Marketing for details.
2. Overbar (¯) may not be to scale.
3. MLF[®] is a GREEN RoHS compliant package. Lead finish is NiPdAu. Mold compound is Halogen Free.
4. MLF[®] (ML) package (Pin 1 identified = ■).
5. Thin MLF[®] (MT) package (Pin 1 identified = ▲).
6. Contact factory for availability.

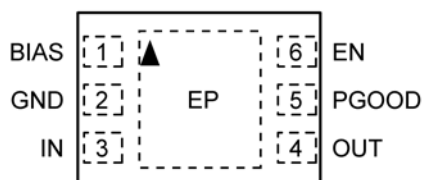
Pin Configuration



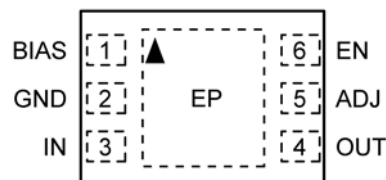
6-pin 2mm x 2mm MLF[®] - Fixed (ML)



6-pin 2mm x 2mm MLF[®] - Adjustable (ML)



6-pin 2mm x 2mm Thin MLF[®] - Fixed (MT)



6-pin 2mm x 2mm Thin MLF[®] - Adjustable (MT)

Pin Description

Fixed	ADJ	Pin Name	Pin Function
1	1	BIAS	Bias Supply. The bias supply is the power supply for the internal circuitry of the regulator.
2	2	GND	Ground. Ground pins and exposed pad must be connected externally.
3	3	IN	Input Supply. Drain of NMOS pass transistor which is the power input voltage for regulator. The NMOS pass transistor steps down this input voltage to create the output voltage.
4	4	OUT	Output. Output Voltage of Regulator.
5	–	PGOOD	Power Good Output. Open-drain output. Output is driven low when the output voltage is less than the power good threshold of its programmed nominal output voltage. When the output goes above the power good threshold, the open-drain output goes high-impedance, allowing it to be pulled up to a fixed voltage.
–	5	ADJ	Adjust Input. Connect external resistor divider to program the output voltage.
6	6	EN	Enable: TTL/CMOS compatible input. Logic high = enable, logic low = shutdown. Do not leave floating.
EP	EP	GND	Exposed thermal pad. Connect to the ground plane to maximize thermal performance.

Absolute Maximum Ratings⁽¹⁾

IN Supply Voltage (V_{IN})	–0.3V to +4V
Bias Supply Voltage (V_{BIAS})	–0.3V to +6V
Enable Voltage (V_{EN})	–0.3V to +6V
Power Good Voltage (V_{PGOOD})	–0.3V to +6V
ADJ Pin Voltage (V_{ADJ})	–0.3V to +6V
OUT Pin Voltage (V_{OUT})	–0.3V to V_{IN}
Lead Temperature (soldering, 10 sec.)	260°C
Storage Temperature (T_S)	–65°C to +150°C
ESD Rating ⁽³⁾	2kV HBM

Operating Ratings⁽²⁾

IN Supply Voltage (V_{IN})	+1.0V to +3.6V ($V_{IN} < V_{BIAS}$)
Bias Voltage (V_{BIAS})	+2.3V to +5.5V
Enable Voltage (V_{EN})	0V to V_{BIAS}
Power Good Voltage (V_{PGOOD})	0V to V_{BIAS}
Output Voltage Range	0.4V to 2.0V
Junction Temperature (T_J)	–40°C to +125°C
Ambient Temperature (T_A)	–40°C to +85°C
Junction Thermal Resistance	
2mm x 2mm MLF [®] -6L (θ_{JA})	90°C/W
2mm x 2mm MLF [®] -6L (θ_{JC})	45°C/W
2mm x 2mm Thin MLF [®] -6L (θ_{JA})	90°C/W
2mm x 2mm Thin MLF [®] -6L (θ_{JC})	45°C/W

Electrical Characteristics⁽⁴⁾

$V_{IN} = V_{OUT} + 0.5V$; $V_{BIAS} = V_{OUT} + 2.1V$; $C_{OUT} = 1\mu F$; $I_{OUT} = 100\mu A$; $T_J = 25^\circ C$, **bold** values indicate $-40^\circ C \leq T_J \leq +125^\circ C$, unless noted.

Parameter	Condition	Min.	Typ.	Max.	Units
Input Supply					
Input Voltage Range (V_{IN})		1.0		3.6	V
V_{IN} UVLO Threshold ⁽⁵⁾	V_{IN} Rising	0.7	0.85	1.0	V
V_{IN} UVLO Hysteresis			40		mV
Ground Current in Shutdown (I_{GND})	$V_{EN} \leq 0.2V$ (Regulator Shutdown)		0.1	1.0	μA
Ground Current (I_{GND})	$I_{OUT} = 500mA$; $V_{IN} = V_{OUT} + 0.5V$		6	15	μA
Bias Supply					
BIAS Input Voltage (V_{BIAS})		2.3		5.5	V
V_{BIAS} UVLO Threshold ⁽⁵⁾	V_{BIAS} Rising	1.7	2.1	2.3	V
V_{BIAS} UVLO Hysteresis			75		mV
Dropout voltage ($V_{BIAS} - V_{OUT}$)	$I_{OUT} = 100mA$		1.15		V
	$I_{OUT} = 500mA$		1.25	2.1	V
V_{BIAS} Supply Current (I_{BIAS})	$I_{OUT} = 1mA$; $V_{BIAS} = V_{OUT} + 2.1V$		330	500	μA
V_{BIAS} Supply Current in Shutdown (I_{BIAS})	$V_{EN} \leq 0.2V$ (Regulator Shutdown)		0.1	1.0	μA
Output Voltage					
Dropout voltage ($V_{IN} - V_{OUT}$)	$I_{OUT} = 100mA$		9	50	mV
	$I_{OUT} = 500mA$		44	120	mV
Output Voltage Accuracy	$I_{OUT} = 100\mu A$	-1.5		+1.5	%
	$I_{OUT} = 100\mu A$	-2.0		+2.0	%
V_{BIAS} Line Regulation	$V_{BIAS} = V_{OUT} + 2.1V$ to 5.5V	-0.1	0.015	0.1	%/V

Electrical Characteristics⁽⁴⁾

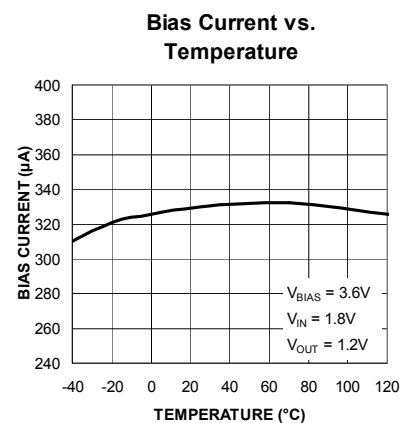
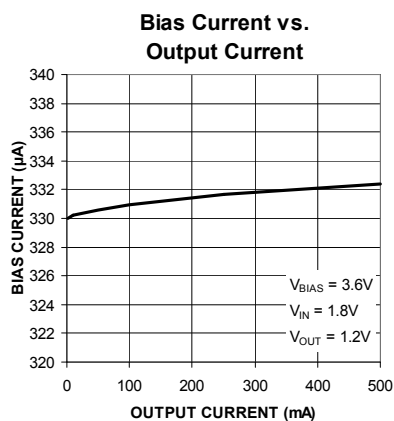
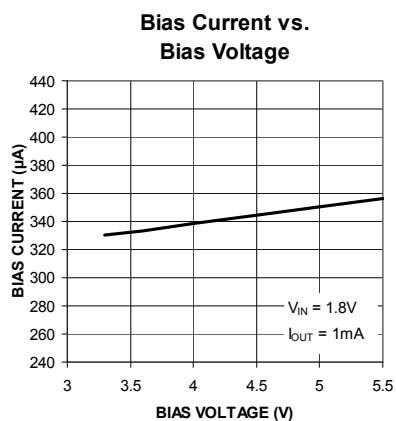
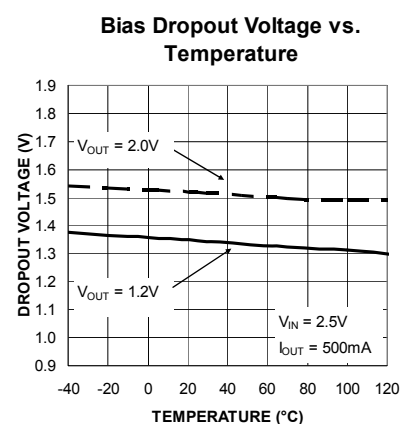
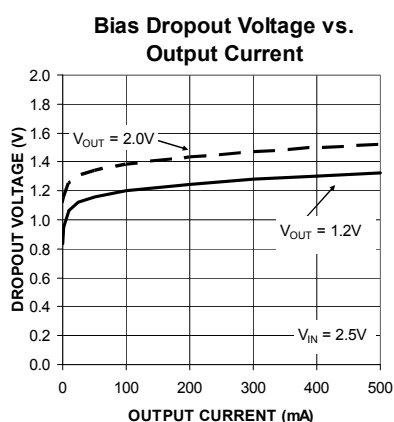
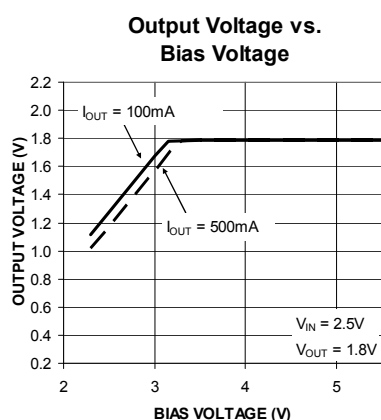
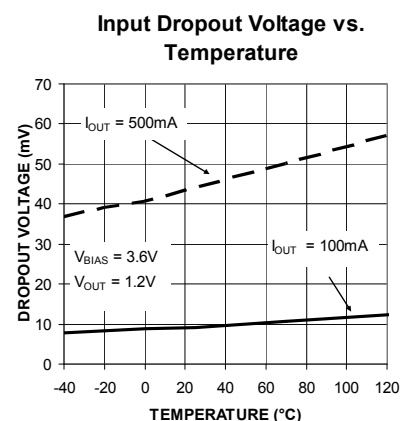
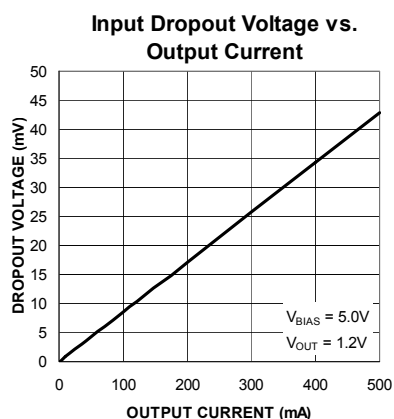
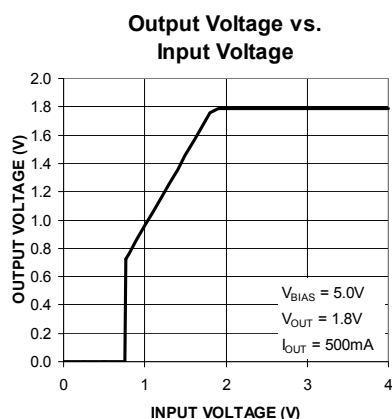
$V_{IN} = V_{OUT} + 0.5V$; $V_{BIAS} = V_{OUT} + 2.1V$; $C_{OUT} = 1\mu F$; $I_{OUT} = 100\mu A$; $T_J = 25^\circ C$, **bold** values indicate $-40^\circ C \leq T_J \leq +125^\circ C$, unless noted.

Parameter	Condition	Min.	Typ.	Max.	Units
V_{IN} Line Regulation	$V_{IN} = V_{OUT} + 0.5V$ to $3.6V$	-0.05	0.005	0.05	%/V
Load Regulation	$I_{OUT} = 10mA$ to $500mA$		0.2	0.5	%
Current Limit					
Short Circuit Current Limit	$V_{IN} = 2.7V$; $V_{OUT} = 0V$	0.6	1.6	2.5	A
Enable Input					
EN Logic Level High		1.0	0.77		V
EN Logic Level Low			0.67	0.2	V
EN Hysteresis			100		mV
Enable Bias Current	$V_{EN} \leq 0.2V$ (Regulator Shutdown)		1	2	μA
	$V_{EN} = 1.0V$ (Regulator Enabled)		6	10	μA
Turn-on Time	$C_{OUT} = 1\mu F$; 90% of typical V_{OUT}		15	500	μs
Thermal Protection					
Over-Temperature Shutdown	T_J Rising		160		$^\circ C$
Over-Temperature Shutdown Hysteresis			20		$^\circ C$
Power Good					
Power Good Threshold Voltage	V_{OUT} Rising		91	95	%
	V_{OUT} Falling	85	89		%
Power Good Hysteresis			2		%
Power Good Output Low Voltage	$I_{PG} = 250\mu A$		0.02	0.1	V
Power Good Leakage Current	$V_{PG} = 5.0V$	-1	0.01	+1	μA
Reference Voltage (Adjustable Option Only)					
Feedback Reference Voltage	$I_{OUT} = 100\mu A$	0.394	0.4	0.406	V
	$I_{OUT} = 100\mu A$	0.392		0.408	V
FB Bias Current	$V_{FB} = 0.8V$		20		nA
Output Voltage Noise and Ripple Rejection					
Output Voltage Noise	$f = 10Hz$ to $100kHz$; $I_{OUT} = 100mA$; $C_{OUT} = 1\mu F$		63		μV_{RMS}
Ripple Rejection	$f = 10kHz$; $C_{OUT} = 1.0\mu F$; $I_{OUT} = 100mA$		50		dB
	$f = 100kHz$; $C_{OUT} = 1.0\mu F$; $I_{OUT} = 100mA$		37		dB

Notes:

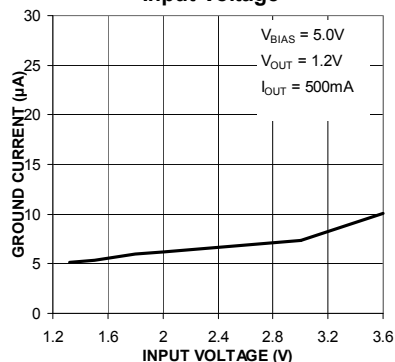
- Exceeding the absolute maximum rating may damage the device.
- The device is not guaranteed to function outside its operating rating.
- Devices are ESD sensitive. Handling precautions recommended. Human body model, $1.5k\Omega$ in series with $100pF$.
- Specification for packaged product only.
- Both V_{IN} and V_{BIAS} UVLO thresholds must be met for the output voltage to turn-on. If either of the two input voltages is below the UVLO thresholds, the output is disabled.

Typical Characteristics

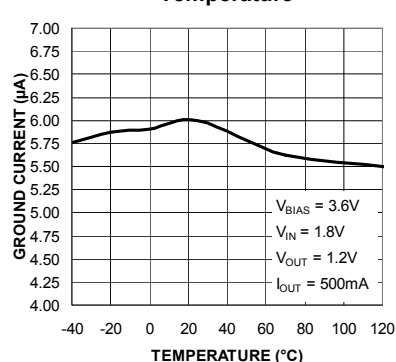


Typical Characteristics (Continued)

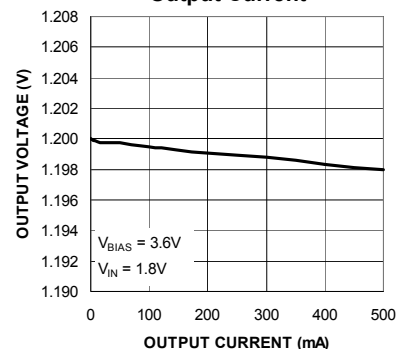
**Ground Current vs.
Input Voltage**



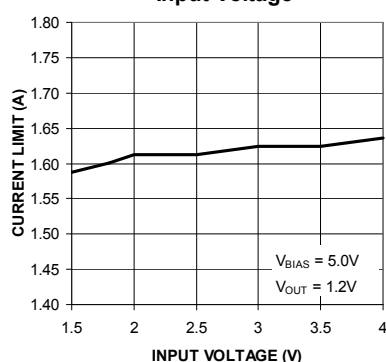
**Ground Current vs.
Temperature**



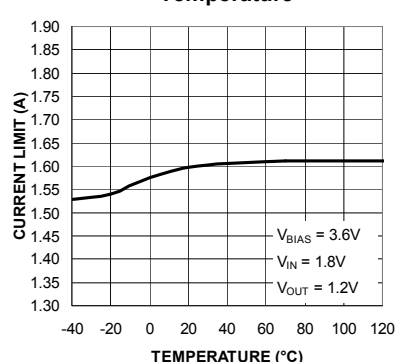
**Output Voltage vs.
Output Current**



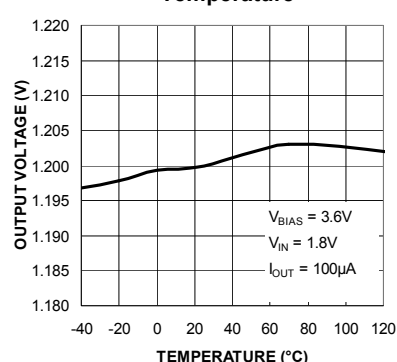
**Current Limit vs.
Input Voltage**



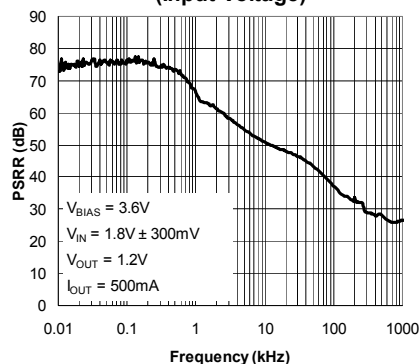
**Current Limit vs.
Temperature**



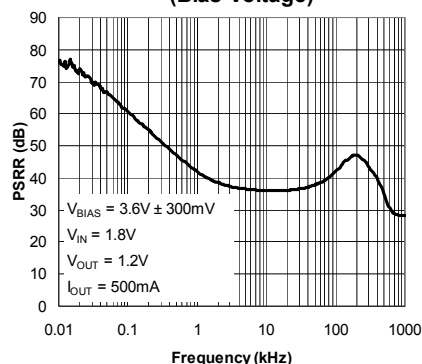
**Output Voltage vs.
Temperature**



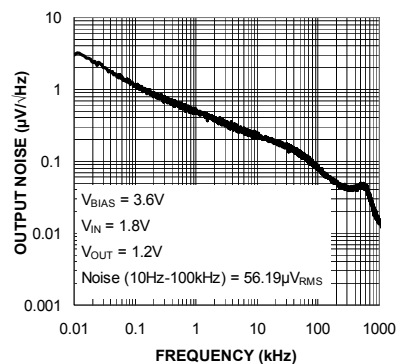
**Power Supply Ripple Rejection
(Input Voltage)**



**Power Supply Ripple Rejection
(Bias Voltage)**

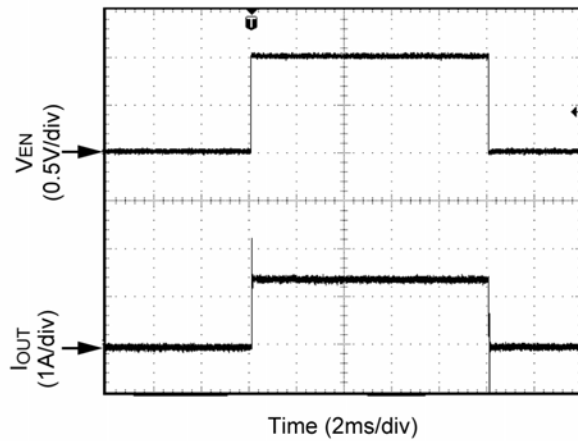


Output Noise

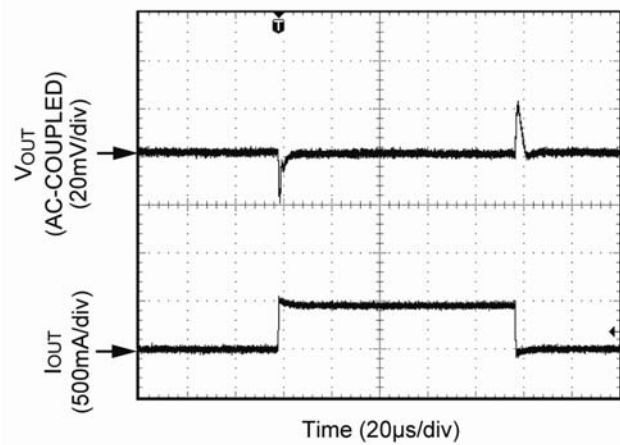


Functional Characteristics

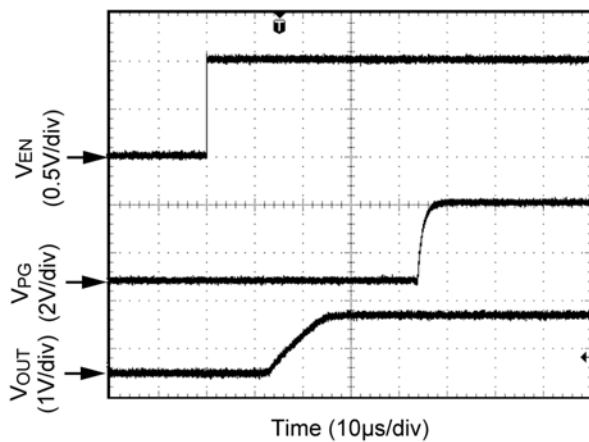
Enabled Into Short Circuit



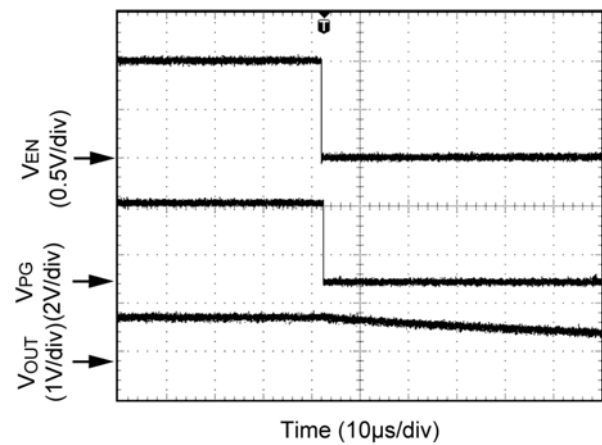
Load Transient Response



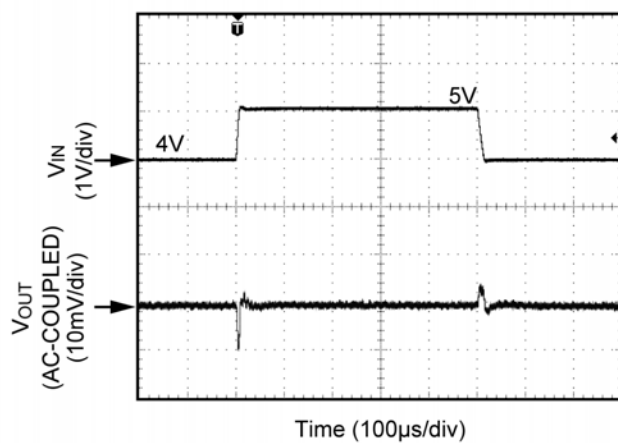
Enable Turn-On Time



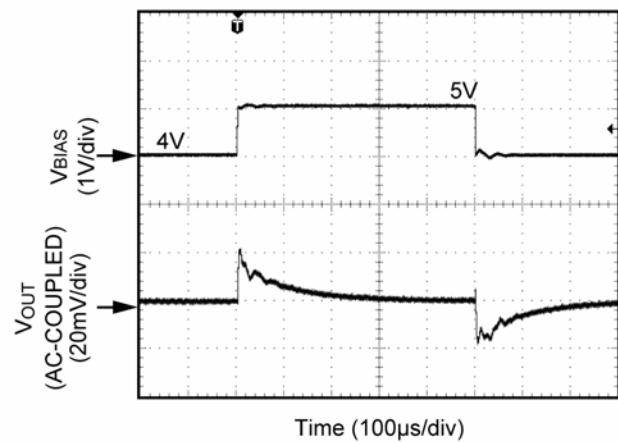
Enable Turn-Off Time



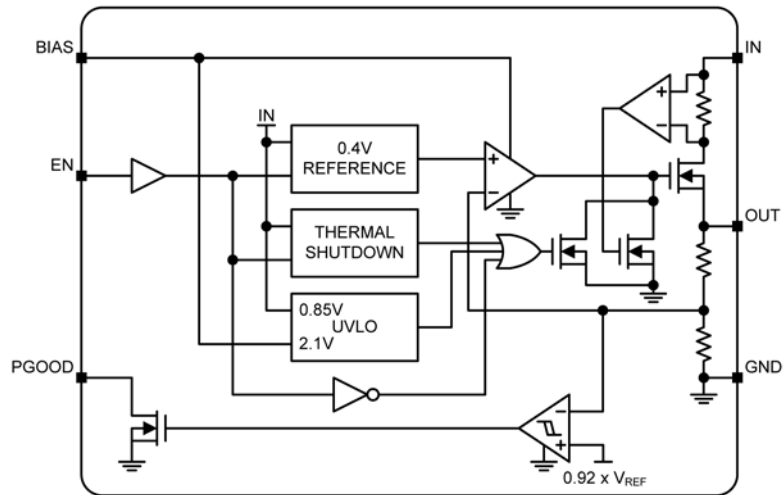
Input Line Transient



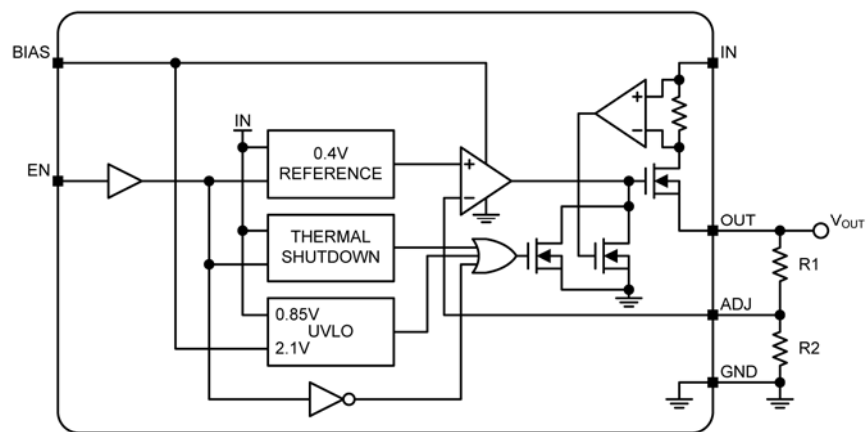
Bias Line Transient



Functional Diagram



MIC47050 Fixed Output Block Diagram



MIC47050 Adjustable Output Block Diagram

Functional Description

The MIC47050 is a high-speed, ultra-low dropout, dual supply NMOS ULDO™ designed to take advantage of point-of-load applications that use multiple supply rails to generate a low-voltage, high-current power supply. The MIC47050 can source 0.5A of output current while only requiring a 1μF ceramic output capacitor for stability. The MIC47050 regulator is fully protected from damage due to fault conditions, offering linear current limiting and thermal shutdown.

Bias Supply Voltage

V_{BIAS}, requiring relatively light current, provides power to the control portion of the MIC47050. Bypassing on the bias pin is recommended to improve performance of the regulator during line and load transients. Small 0.1μF ceramic capacitors from V_{BIAS}-to-ground help reduce high frequency noise from being injected into the control circuitry from the bias rail and are good design practice.

Input Supply Voltage

V_{IN} provides the supply to power the LDO. The minimum input voltage is 1.0V. This allows conversion from low voltage supplies to reduce the power dissipation in the pass element.

Input Capacitor

The MIC47050 is a high-performance, high bandwidth device. Therefore, it requires a well-bypassed input supply for optimal performance. A 1μF capacitor is the minimum required for stability. A 10μF ceramic capacitor is recommended for most applications, especially if the LDO's headroom (V_{IN} - V_{OUT}) is small and/or large load transients are present. Fast load transient and low headroom requires a larger input filter capacitor to ensure that the regulator does not drop out of regulation. A 10μF will better attenuate any voltage glitches from exceeding the maximum voltage rating of the part.

Additional high-frequency capacitors, such as small-valued NPO dielectric-type capacitors, help filter out high-frequency noise and are good practice in any RF-based circuit.

X7R and X5R dielectric ceramic capacitors are recommended because of their temperature performance. X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors are not recommended since they change value by as much as 50% and 60% respectively over their operating temperature ranges. To use a ceramic-chip capacitor with Y5V dielectric, the value must be much higher than an X7R ceramic or a tantalum capacitor to ensure the same capacitance value over the operating temperature range.

Tantalum capacitors have a very stable dielectric (10% over their operating temperature range) and can also be used with this device. See the *Typical Characteristic* section for examples of load transient response.

Output Capacitor

The MIC47050 requires an output capacitor of 1μF or greater to maintain stability. The design is optimized for use with low-ESR ceramic chip capacitors. High-ESR capacitors may cause high-frequency oscillation. The output capacitor can be increased, but performance has been optimized for a 1μF ceramic output capacitor and does not improve significantly with larger capacitance.

The output capacitor type and placement criteria are the same as the input capacitor. See the "Input Capacitor" subsection for a detailed description.

Minimum Load Current

The MIC47050, unlike most other regulators, does not require a minimum load to maintain output voltage regulation.

Adjustable Regulator Design

The MIC47050 adjustable version allows programming the output voltage from 0.4V to 2.0V. Two external resistors are required. The R1 resistor value between V_{OUT} and the ADJ pin should not exceed 10kΩ, as larger values can cause instability. R2 connects between the ADJ pin and ground. The resistor values are calculated as follows:

$$R1 = R2 \times \left(\frac{V_{OUT}}{V_{REF}} - 1 \right)$$

Where V_{OUT} is the desired output voltage and V_{REF} is the internal reference voltage.

Enable/Shutdown

The MIC47050 comes with a single active-high enable pin that allows the regulator to be disabled. Forcing the enable pin low disables the regulator and sends it into a "zero" off-mode-current state. In this state, current consumed by the regulator goes nearly to zero. Forcing the enable pin high enables the output voltage. The active-high enable pin uses CMOS technology and the enable pin cannot be left floating; a floating enable pin may cause an indeterminate state on the output.

Power Good (PGOOD)

The Power Good (PGOOD) pin is an open drain output that goes low when the output voltage (fixed version) drops below the PGOOD threshold voltage.

The pull-up resistor value should be large enough to guarantee a proper “low” voltage when the PGOOD pin pulls low. The PGOOD low voltage is typically 0.1V at 250μA current. A 10kΩ resistor or greater is recommended when pulling up to 3.3V bias.

If the PGOOD function is not required, the PGOOD pin may be left unconnected.

Thermal Shutdown

The MIC47050 has an internal over-temperature protection feature. This feature is for protection only. The device should never be intentionally operated near this temperature as this may reduce long term reliability. The device will turn off when the over-temperature threshold is exceeded. A 20°C hysteresis is built in to allow the device to cool before turning back on.

Thermal Considerations

The MIC47050 is designed to provide 0.5A of continuous current in a very small package. Maximum ambient operating temperature can be calculated based on the output current and the voltage drop across the part. Given that the input voltage is 1.8V, the output voltage is 1.2V and the output current is 0.5A. The actual power dissipation of the regulator circuit can be determined using the equation:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND} + V_{BIAS} \times I_{BIAS}$$

Because this device is CMOS, the ground current is insignificant for power dissipation and can be ignored for this calculation.

$$P_D = (1.8V - 1.2V) \times 0.5A = 0.3W$$

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation:

$$P_{D(MAX)} = \left[\frac{T_{J(MAX)} - T_A}{\Theta_{JA}} \right]$$

$T_{J(MAX)} = 125^\circ\text{C}$, the maximum junction temperature of the die.

Θ_{JA} thermal resistance = 90°C/W .

Table 1 shows junction-to-ambient thermal resistance for the MIC47050 in the MLF® or Thin MLF® package.

Package	Θ_{JA} Recommended Min. Footprint	Θ_{JC}
6-pin 2mm x 2mm MLF®	90°C/W	45°C/W
6-pin 2mm x 2mm Thin MLF®	90°C/W	45°C/W

Table 1. Thermal Resistance

Substituting P_D for $P_{D(max)}$ and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit. The junction-to-ambient thermal resistance for the minimum footprint is 90°C/W . The maximum power dissipation must not be exceeded for proper operation. For example, when operating the MIC47050-1.2YML at an input voltage of 1.8V and a 0.5A load with a minimum footprint layout, the maximum ambient operating temperature T_A can be determined as follows:

$$T_A = T_{J(MAX)} - \Theta_{JA} \times P_{D(MAX)}$$

$$T_A = 125^\circ\text{C} - 90^\circ\text{C/W} \times 0.3W$$

$$T_A = 98^\circ\text{C}$$

Therefore, a 1.2V application with 0.5A of output current can accept an ambient operating temperature of 98°C in a 2mm x 2mm MLF® or Thin MLF® package.

Thermal Measurements

Measuring the IC's case temperature is recommended to insure it is within its operating limits. Although this might seem like a very elementary task, it is easy to get erroneous results. The most common mistake is to use the standard thermal couple that comes with a thermal meter. This thermal couple wire gauge is large, typically 22 gauge, and behaves like a heatsink, resulting in a lower case measurement.

Two methods of temperature measurement are using a smaller thermal couple wire or an infrared thermometer. If a thermal couple wire is used, it must be constructed of 36 gauge wire or higher (smaller wire size) to minimize the wire heat-sinking effect.

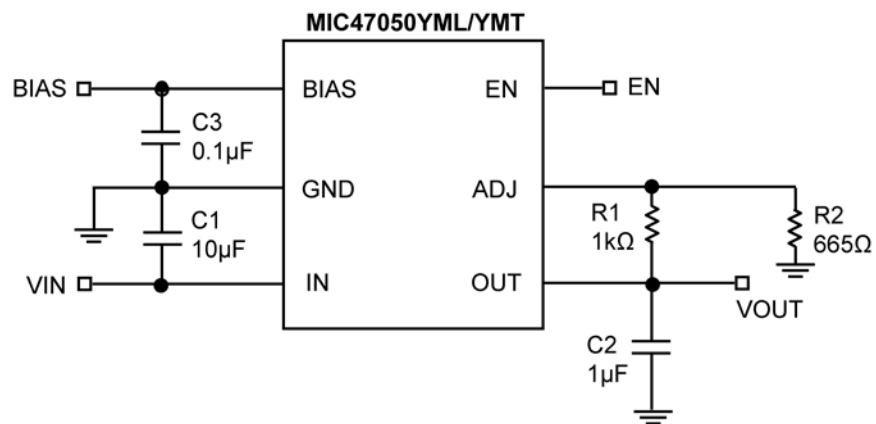
In addition, the thermal couple tip must be covered in either thermal grease or thermal glue to make sure that the thermal couple junction is making good contact with the case of the IC. Omega brand thermal couple (5SC-TT-K-36-36) is adequate for most applications.

Wherever possible, an infrared thermometer is recommended. The measurement spot size of most infrared thermometers is too large for an accurate reading on a small form factor ICs. However, a IR thermometer from Optris has a 1mm spot size, which makes it a good choice for the 2mm x 2mm MLF[®] or Thin MLF[®] package. An optional stand makes it easy to hold the beam on the IC for long periods of time.

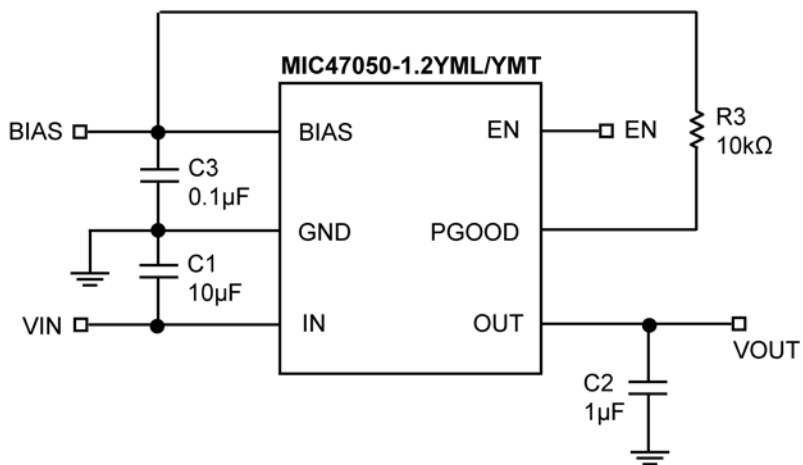
For a full discussion of heat sinking and thermal effects of voltage regulators, refer to the "Regulator Thermals" section of Micrel's *Designing with Low-Dropout Voltage Regulators* handbook. This information can be found on Micrel's website at:

http://www.micrel.com/PDF/other/LDOBk_ds.pdf

MIC47050 Typical Application Schematic



MIC47050 Adjustable Output



MIC47050 Fixed Output

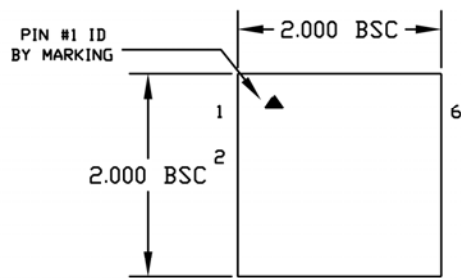
MIC47050 Bill of Materials

Item	Part Number	Manufacturer	Description	Qty.
C1	GRM21BR60J106ME19	Murata ⁽¹⁾	Ceramic Capacitor, 10μF, 6.3V, X5R, 0603 size	1
	C1608X5R0J106MT	TDK ⁽²⁾	Ceramic Capacitor, 10μF, 6.3V, X5R, 0603 size	
C2	GRM155R61A105KE15D	Murata ⁽¹⁾	Capacitor, 1μF, 10V, X5R, 0402 size	1
	C1005X5R0J105KT	TDK ⁽²⁾	Capacitor, 1μF, 10V, X5R, 0402 size	
C3	06035D104MAT2A	AVX ⁽³⁾	Ceramic Capacitor, 0.1μF, 50V, X5R, 0603 size	1
R1	CRCW06031001FRT1	Vishay Dale ⁽⁴⁾	Resistor, 1k (0603 size), 1%	1
R2	CRCW06036650FRT1	Vishay Dale ⁽⁴⁾	Resistor, 665 (0603 size), 1%	1
R3	CRCW06031002FRT1	Vishay Dale ⁽⁴⁾	Resistor, 10k (0603 size), 1%	1
U1	MIC47050YML	Micrel, Inc. ⁽⁵⁾	Low Input and Output 500mA ULDO™ - Adjustable Output	1
	MIC47050YMT		Low Input and Output 500mA ULDO™ - Adjustable Output	
	MIC47050-1.2YML		Low Input and Output 500mA ULDO™ - Fixed 1.2V Output	
	MIC47050-1.2YMT		Low Input and Output 500mA ULDO™ - Fixed 1.2V Output	
	MIC47050-1.8YML		Low Input and Output 500mA ULDO™ - Fixed 1.8V Output	
	MIC47050-1.8YMT		Low Input and Output 500mA ULDO™ - Fixed 1.8V Output	

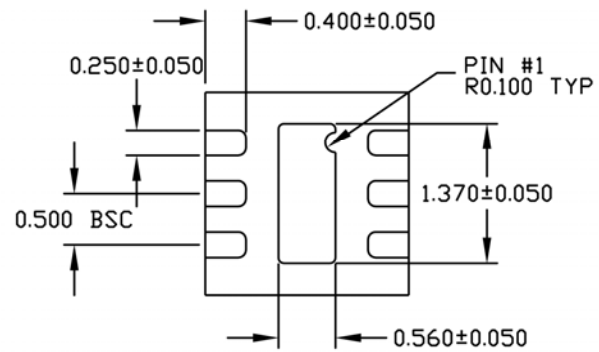
Notes:

1. Murata: www.murata.com.
2. TDK: www.tdk.com.
3. AVX: www.avx.com.
4. Vishay: www.vishay.com.
5. Micrel, Inc.: www.micrel.com.

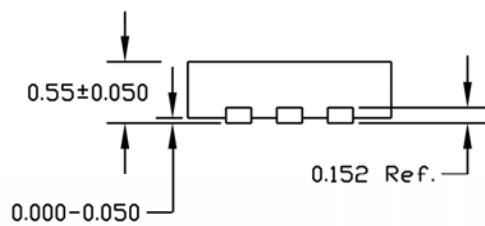
Package Information



TOP VIEW



BOTTOM VIEW



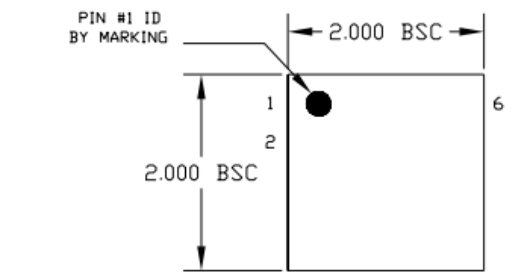
SIDE VIEW

NOTE:

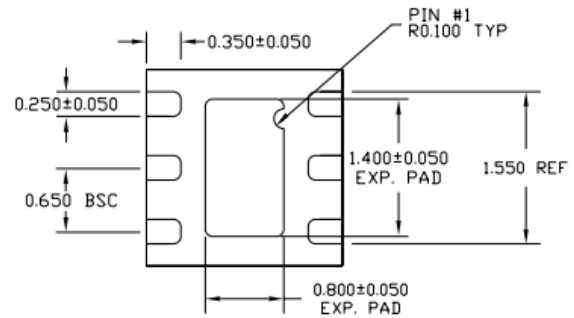
1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. MAX. PACKAGE WARPAGE IS 0.05 mm.
3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
4. PIN #1 TRIANGLE ID ON TOP WILL BE LASER MARKED.

6-Pin 2mm × 2mm Thin MLF[®] (MT)

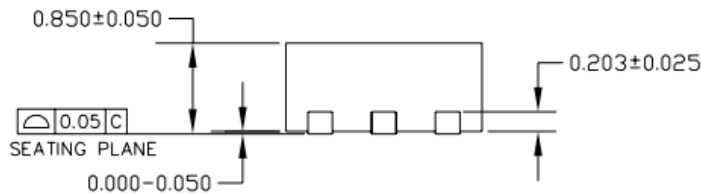
Package Information (Continued)



TOP VIEW



BOTTOM VIEW



SIDE VIEW

NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. MAX. PACKAGE WARPAGE IS 0.05 mm.
3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
4. PIN #1 ID ON TOP WILL BE LASER MARKED.

6-Pin 2mm x 2mm MLF[®] (ML)

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